

# MOSFET

## OptiMOS™ 6 Power-Transistor, 200 V

### Features

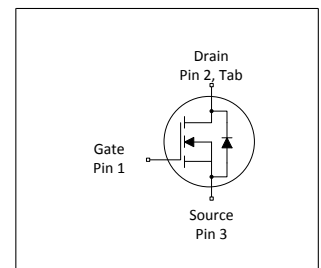
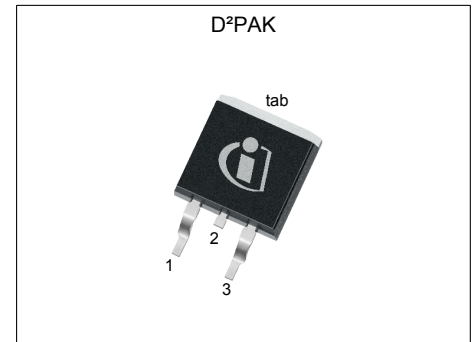
- N-channel, normal level
- Very low on-resistance  $R_{DS(on)}$
- Excellent gate charge x  $R_{DS(on)}$  product (FOM)
- Very low reverse recovery charge ( $Q_{rr}$ )
- High avalanche energy rating
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020
- 100% avalanche tested

### Product validation

Fully qualified according to JEDEC for Industrial Applications

**Table 1 Key Performance Parameters**

| Parameter        | Value | Unit       |
|------------------|-------|------------|
| $V_{DS}$         | 200   | V          |
| $R_{DS(on),max}$ | 6.8   | m $\Omega$ |
| $I_D$            | 134   | A          |
| $Q_{oss}$        | 232   | nC         |
| $Q_G$            | 73    | nC         |
| $Q_{rr}$         | 391   | nC         |



RoHS

| Type / Ordering Code | Package    | Marking  | Related Links |
|----------------------|------------|----------|---------------|
| IPB068N20NM6         | PG-TO263-3 | 068N20N6 | -             |

## Table of Contents

|   |    |
|---|----|
| Description .....                         | 1  |
| Maximum ratings .....                     | 3  |
| Thermal characteristics .....             | 3  |
| Electrical characteristics .....          | 4  |
| Electrical characteristics diagrams ..... | 6  |
| Package Outlines .....                    | 10 |
| Revision History .....                    | 11 |
| Trademarks .....                          | 11 |
| Disclaimer .....                          | 11 |

## 1 Maximum ratings

at  $T_A=25\text{ °C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                    | Symbol            | Values |      |                          | Unit | Note / Test Condition   |
|--|-------------------|--------|------|--------------------------|------|---|
|  |                   | Min.   | Typ. | Max.                     |      |   |
| Continuous drain current <sup>1)</sup>       | $I_D$             | -      | -    | 134<br>97<br>101<br>15.4 | A    | $V_{GS}=10\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=15\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_A=25\text{ °C}$ , $R_{thJA}=40\text{ °C/W}^2)$ |
| Pulsed drain current <sup>3)</sup>           | $I_{D,pulse}$     | -      | -    | 536                      | A    | $T_C=25\text{ °C}$  |
| Avalanche energy, single pulse <sup>4)</sup> | $E_{AS}$          | -      | -    | 516                      | mJ   | $I_D=77\text{ A}$ , $R_{GS}=25\text{ }\Omega$   |
| Gate source voltage                          | $V_{GS}$          | -20    | -    | 20                       | V    | -   |
| Power dissipation                            | $P_{tot}$         | -      | -    | 300<br>3.8               | W    | $T_C=25\text{ °C}$<br>$T_A=25\text{ °C}$ , $R_{thJA}=40\text{ °C/W}^2)$   |
| Operating and storage temperature            | $T_j$ , $T_{stg}$ | -55    | -    | 175                      | °C   | -   |

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

| Parameter  | Symbol     | Values |      |      | Unit | Note / Test Condition |
|--|------------|--------|------|------|------|-----------------------|
|  |            | Min.   | Typ. | Max. |      |                       |
| Thermal resistance, junction - case  | $R_{thJC}$ | -      | 0.31 | 0.5  | °C/W | -                     |
| Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>2)</sup> | $R_{thJA}$ | -      | -    | 40   | °C/W | -                     |
| Thermal resistance, junction - ambient, minimal footprint                            | $R_{thJA}$ | -      | -    | 62   | °C/W | -                     |

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 4 Static characteristics**

| Parameter                        | Symbol        | Values |            |            | Unit             | Note / Test Condition   |
|----------------------------------|---------------|--------|------------|------------|------------------|---|
|                                  |               | Min.   | Typ.       | Max.       |                  |   |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | 200    | -          | -          | V                | $V_{GS}=0\text{ V}$ , $I_D=1\text{ mA}$   |
| Gate threshold voltage           | $V_{GS(th)}$  | 3.0    | 3.7        | 4.5        | V                | $V_{DS}=V_{GS}$ , $I_D=258\text{ }\mu\text{A}$  |
| Zero gate voltage drain current  | $I_{DSS}$     | -      | 0.1<br>10  | 1<br>100   | $\mu\text{A}$    | $V_{DS}=160\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$<br>$V_{DS}=160\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=125\text{ °C}$ |
| Gate-source leakage current      | $I_{GSS}$     | -      | 10         | 100        | nA               | $V_{GS}=20\text{ V}$ , $V_{DS}=0\text{ V}$  |
| Drain-source on-state resistance | $R_{DS(on)}$  | -      | 5.9<br>5.2 | 6.8<br>6.3 | $\text{m}\Omega$ | $V_{GS}=10\text{ V}$ , $I_D=100\text{ A}$<br>$V_{GS}=15\text{ V}$ , $I_D=100\text{ A}$  |
| Gate resistance                  | $R_G$         | -      | 3.8        | -          | $\Omega$         | -   |
| Transconductance <sup>1)</sup>   | $g_{fs}$      | 32     | 65         | -          | S                | $ V_{DS} \geq 2 I_D /R_{DS(on)max}$ , $I_D=100\text{ A}$  |

**Table 5 Dynamic characteristics**

| Parameter                                  | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|--|--------------|--------|------|------|------|---|
|  |              | Min.   | Typ. | Max. |      |   |
| Input capacitance <sup>1)</sup>            | $C_{iss}$    | -      | 5700 | 7400 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=100\text{ V}$ , $f=1\text{ MHz}$                                      |
| Output capacitance <sup>1)</sup>           | $C_{oss}$    | -      | 910  | 1200 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=100\text{ V}$ , $f=1\text{ MHz}$                                      |
| Reverse transfer capacitance <sup>1)</sup> | $C_{rss}$    | -      | 30   | 52   | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=100\text{ V}$ , $f=1\text{ MHz}$                                      |
| Turn-on delay time                         | $t_{d(on)}$  | -      | 17   | -    | ns   | $V_{DD}=100\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Rise time                                  | $t_r$        | -      | 56   | -    | ns   | $V_{DD}=100\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Turn-off delay time                        | $t_{d(off)}$ | -      | 37   | -    | ns   | $V_{DD}=100\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Fall time                                  | $t_f$        | -      | 29   | -    | ns   | $V_{DD}=100\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |

**Table 6 Gate charge characteristics<sup>2)</sup>**

| Parameter                          | Symbol        | Values |      |      | Unit | Note / Test Condition  |
|------------------------------------|---------------|--------|------|------|------|--|
|                                    |               | Min.   | Typ. | Max. |      |  |
| Gate to source charge              | $Q_{gs}$      | -      | 38   | -    | nC   | $V_{DD}=100\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate charge at threshold           | $Q_{g(th)}$   | -      | 21   | -    | nC   | $V_{DD}=100\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate to drain charge <sup>1)</sup> | $Q_{gd}$      | -      | 14   | 21   | nC   | $V_{DD}=100\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Switching charge                   | $Q_{sw}$      | -      | 31   | -    | nC   | $V_{DD}=100\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate charge total <sup>1)</sup>    | $Q_g$         | -      | 73   | 110  | nC   | $V_{DD}=100\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate plateau voltage               | $V_{plateau}$ | -      | 6.6  | -    | V    | $V_{DD}=100\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate charge total, sync. FET       | $Q_{g(sync)}$ | -      | 63   | -    | nC   | $V_{DS}=0.1\text{ V}$ , $V_{GS}=0\text{ to }10\text{ V}$                     |
| Output charge <sup>1)</sup>        | $Q_{oss}$     | -      | 232  | 302  | nC   | $V_{DS}=100\text{ V}$ , $V_{GS}=0\text{ V}$                                  |

<sup>1)</sup> Defined by design. Not subject to production test.

<sup>2)</sup> See "Gate charge waveforms" for parameter definition

**Table 7 Reverse diode**

| Parameter                             | Symbol        | Values |      |      | Unit | Note / Test Condition  |
|---------------------------------------|---------------|--------|------|------|------|--|
|                                       |               | Min.   | Typ. | Max. |      |  |
| Diode continuous forward current      | $I_S$         | -      | -    | 134  | A    | $T_C=25\text{ °C}$   |
| Diode pulse current                   | $I_{S,pulse}$ | -      | -    | 536  | A    | $T_C=25\text{ °C}$   |
| Diode forward voltage                 | $V_{SD}$      | -      | 0.92 | 1.0  | V    | $V_{GS}=0\text{ V}, I_F=100\text{ A}, T_j=25\text{ °C}$                |
| Reverse recovery time                 | $t_{rr}$      | -      | 53   | -    | ns   | $V_R=100\text{ V}, I_F=50\text{ A}, di_F/dt=100\text{ A}/\mu\text{s}$  |
| Reverse recovery charge <sup>1)</sup> | $Q_{rr}$      | -      | 70   | 140  | nC   | $V_R=100\text{ V}, I_F=50\text{ A}, di_F/dt=100\text{ A}/\mu\text{s}$  |
| Reverse recovery time                 | $t_{rr}$      | -      | 38   | -    | ns   | $V_R=100\text{ V}, I_F=50\text{ A}, di_F/dt=1000\text{ A}/\mu\text{s}$ |
| Reverse recovery charge <sup>1)</sup> | $Q_{rr}$      | -      | 391  | 782  | nC   | $V_R=100\text{ V}, I_F=50\text{ A}, di_F/dt=1000\text{ A}/\mu\text{s}$ |

<sup>1)</sup> Defined by design. Not subject to production test.

### 4 Electrical characteristics diagrams

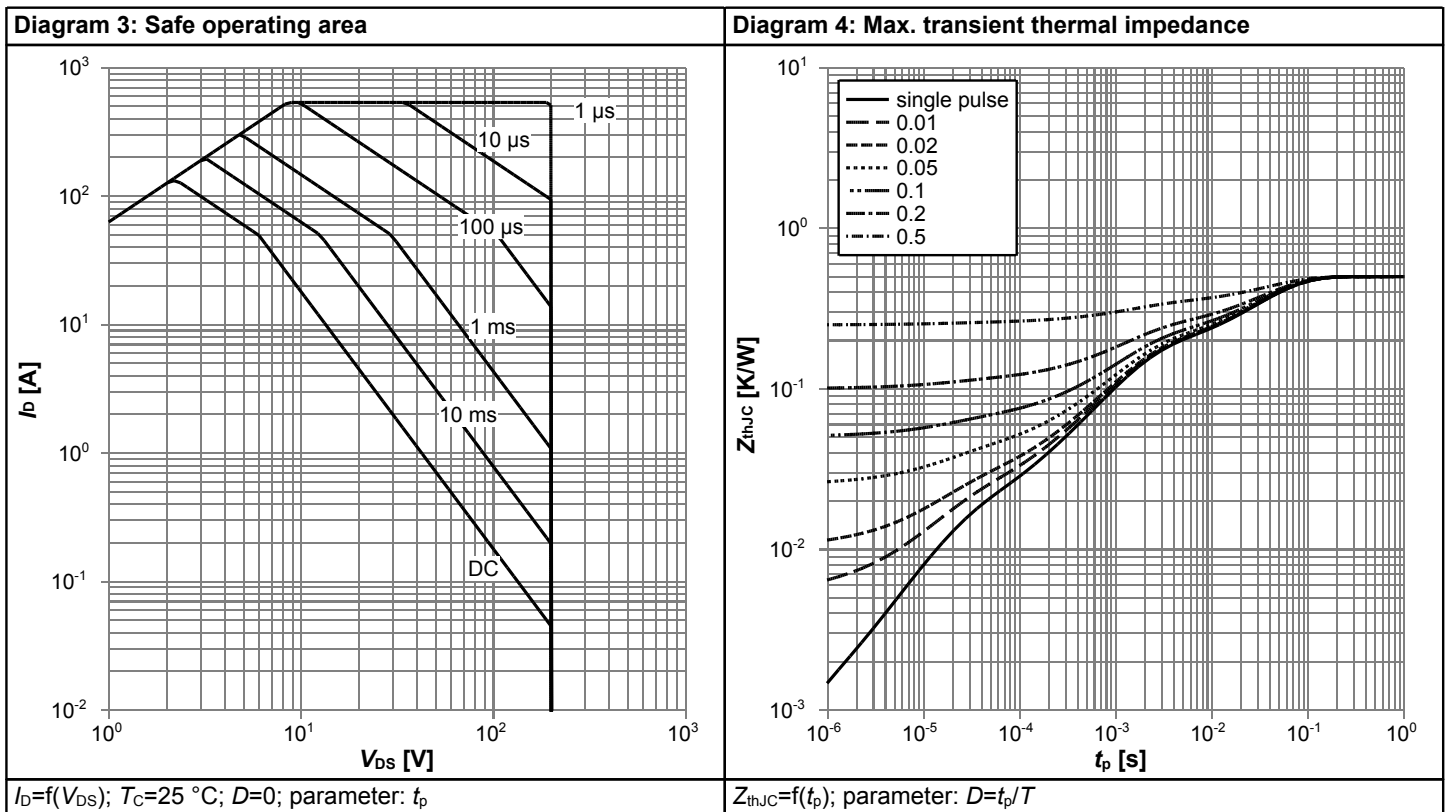
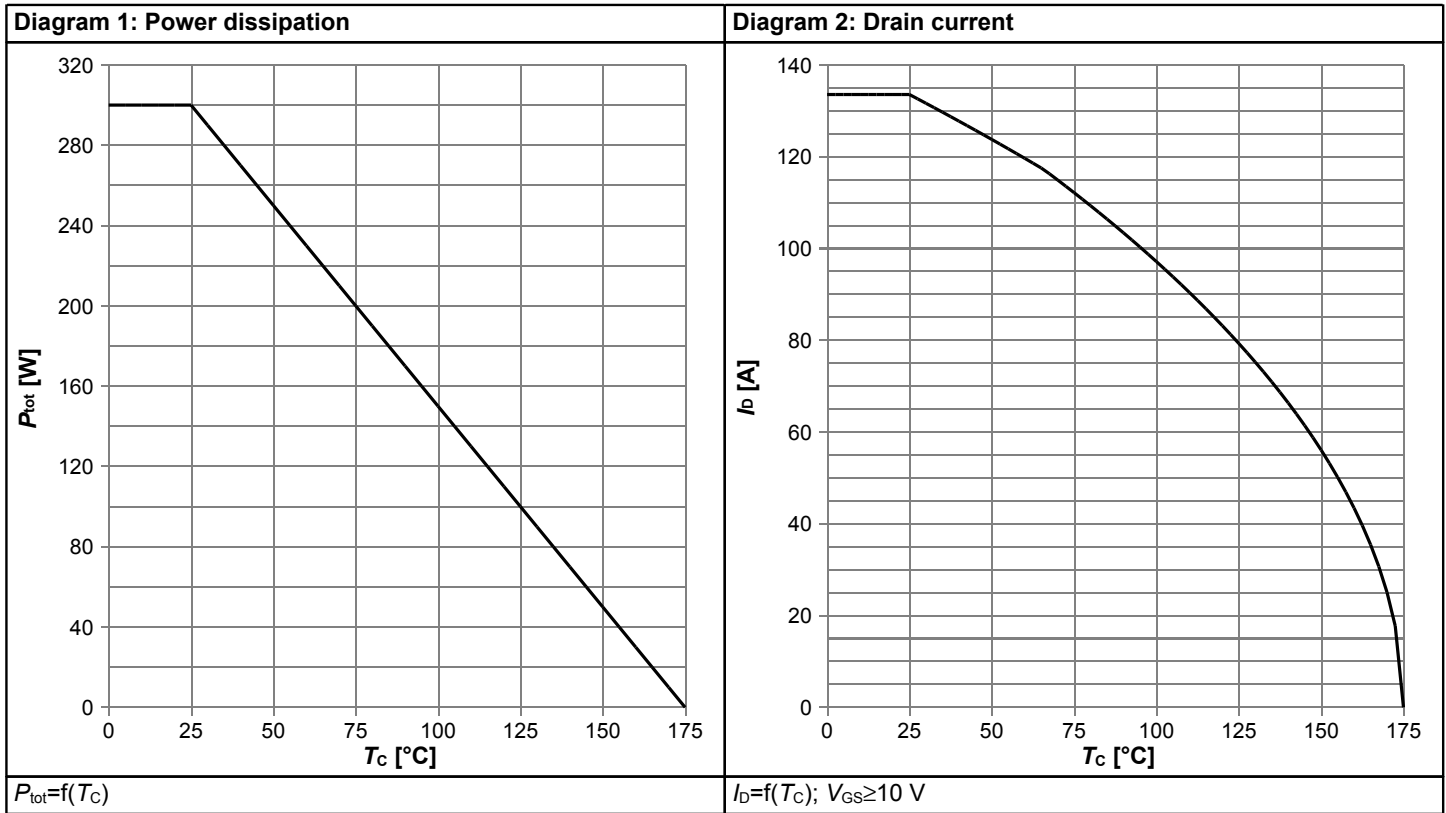
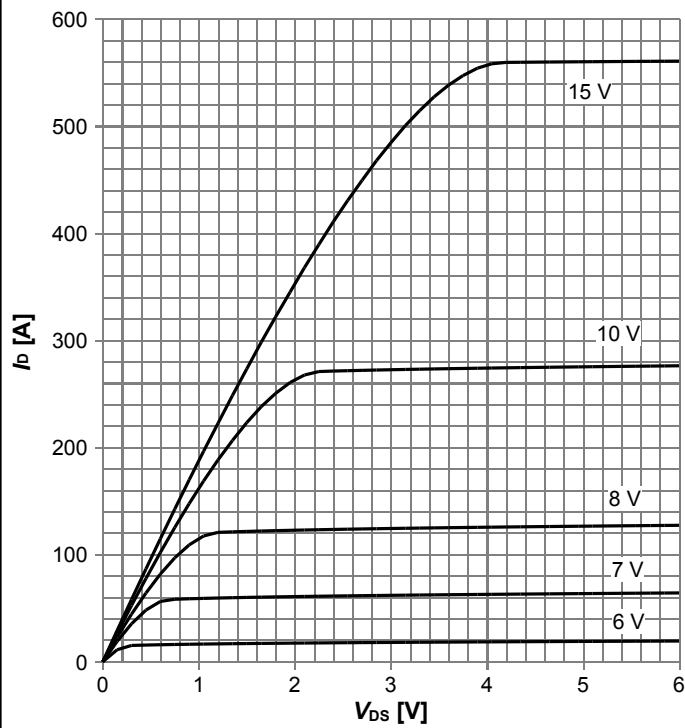
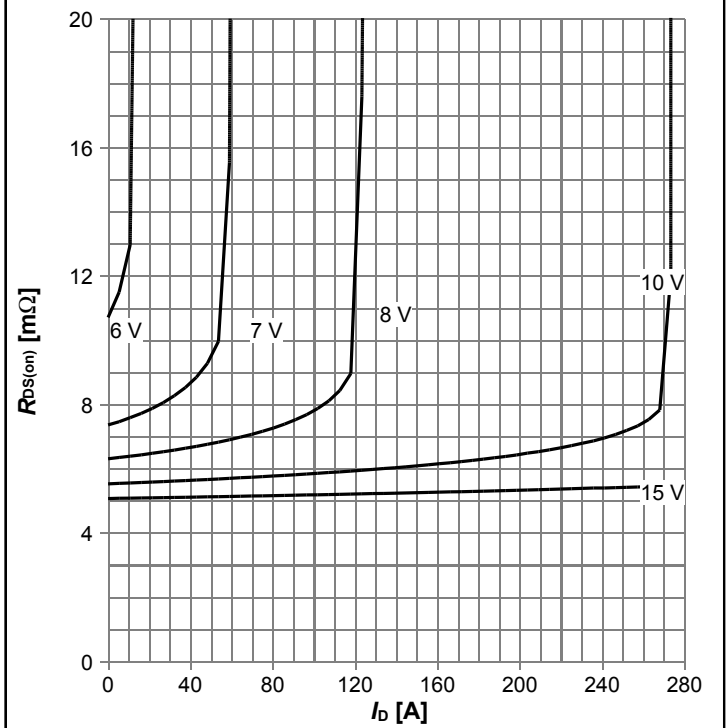


Diagram 5: Typ. output characteristics



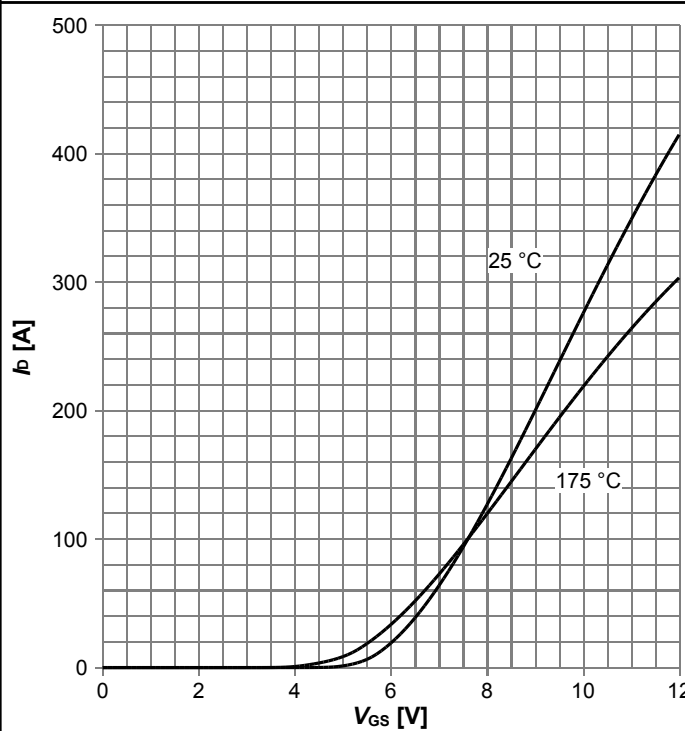
$I_D = f(V_{DS})$ ,  $T_j = 25\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. drain-source on resistance



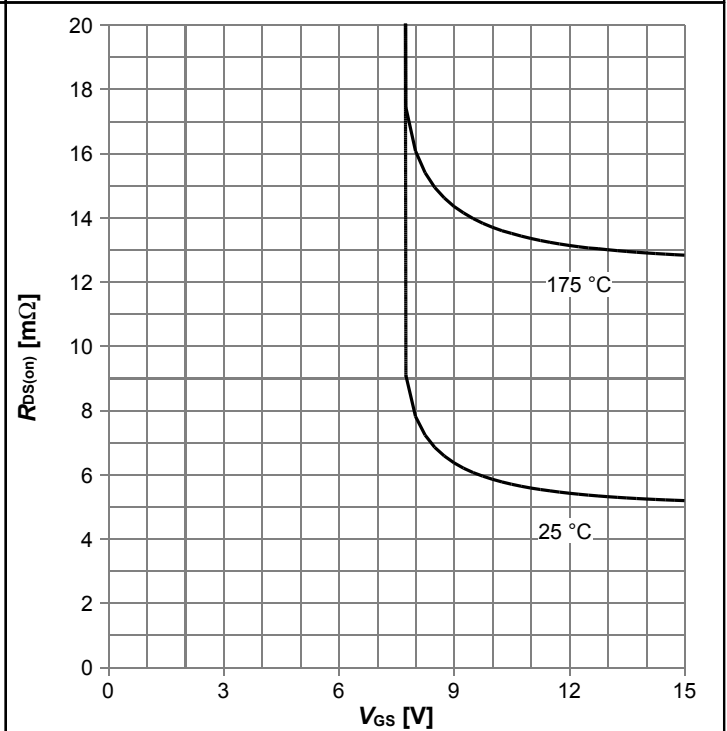
$R_{DS(on)} = f(I_D)$ ,  $T_j = 25\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. transfer characteristics



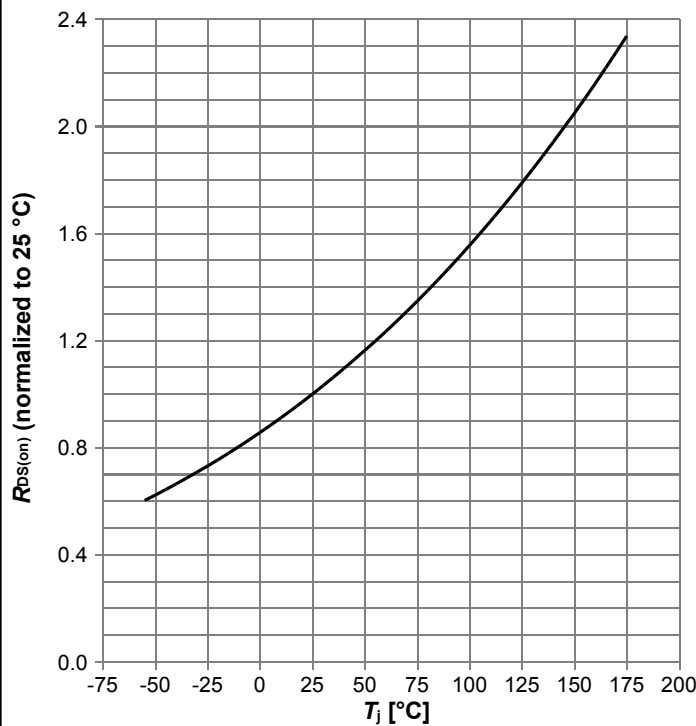
$I_D = f(V_{GS})$ ,  $|V_{DS}| > 2|I_D|R_{DS(on)max}$ ; parameter:  $T_j$

Diagram 8: Typ. drain-source on resistance



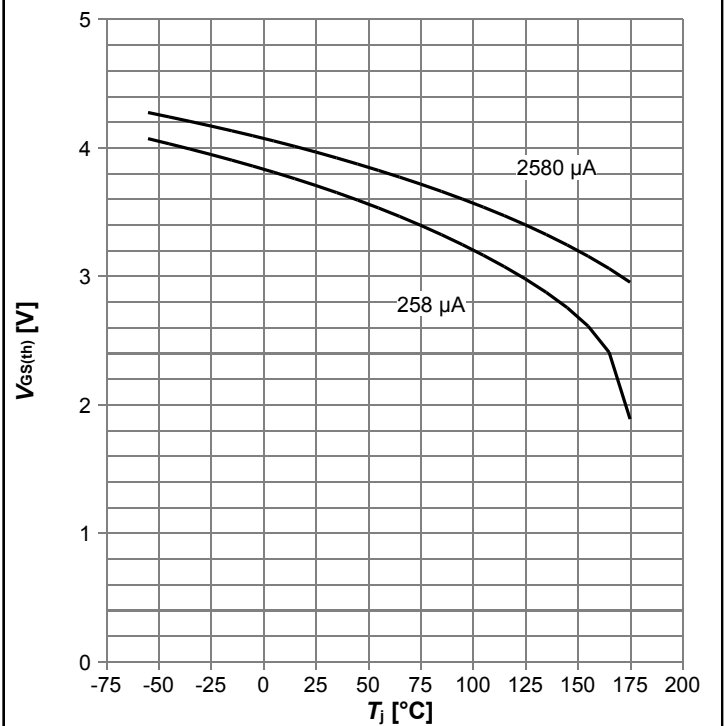
$R_{DS(on)} = f(V_{GS})$ ,  $I_D = 100\text{ A}$ ; parameter:  $T_j$

Diagram 9: Normalized drain-source on resistance



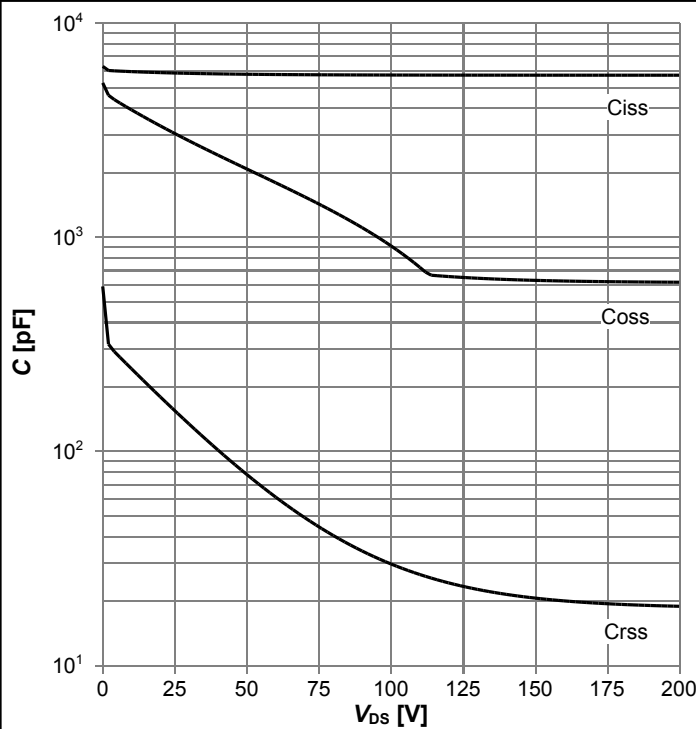
$R_{DS(on)}=f(T_j)$ ,  $I_D=100$  A,  $V_{GS}=10$  V

Diagram 10: Typ. gate threshold voltage



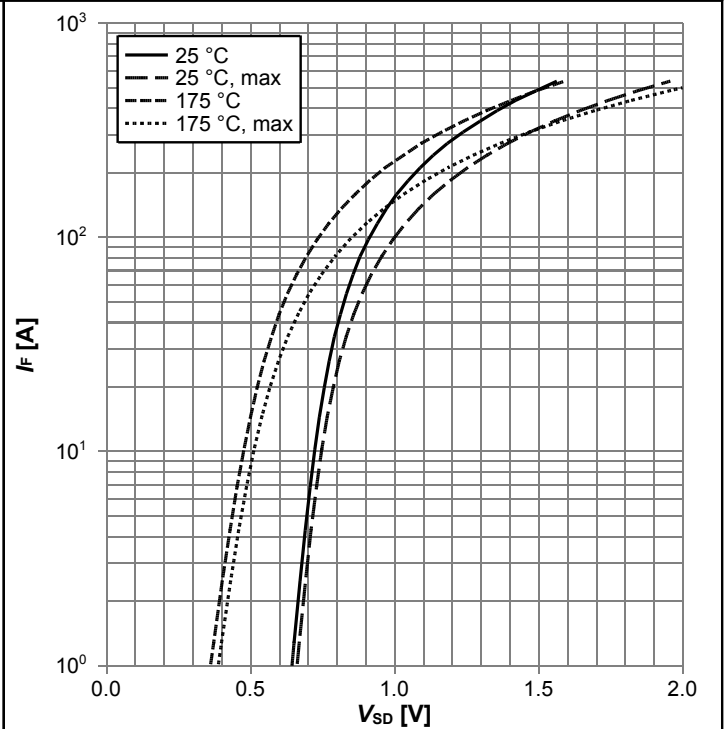
$V_{GS(th)}=f(T_j)$ ,  $V_{GS}=V_{DS}$ ; parameter:  $I_D$

Diagram 11: Typ. capacitances



$C=f(V_{DS})$ ;  $V_{GS}=0$  V;  $f=1$  MHz

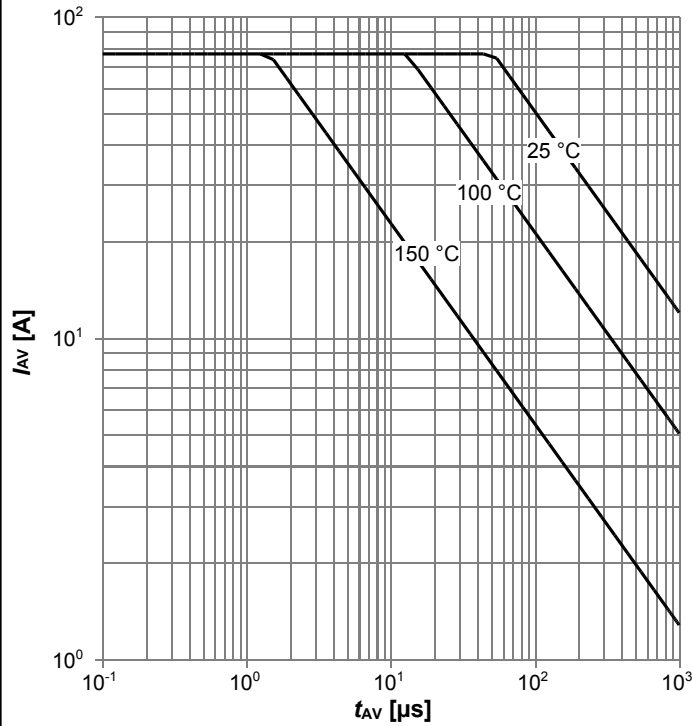
Diagram 12: Forward characteristics of reverse diode



$I_F=f(V_{SD})$ ; parameter:  $T_j$

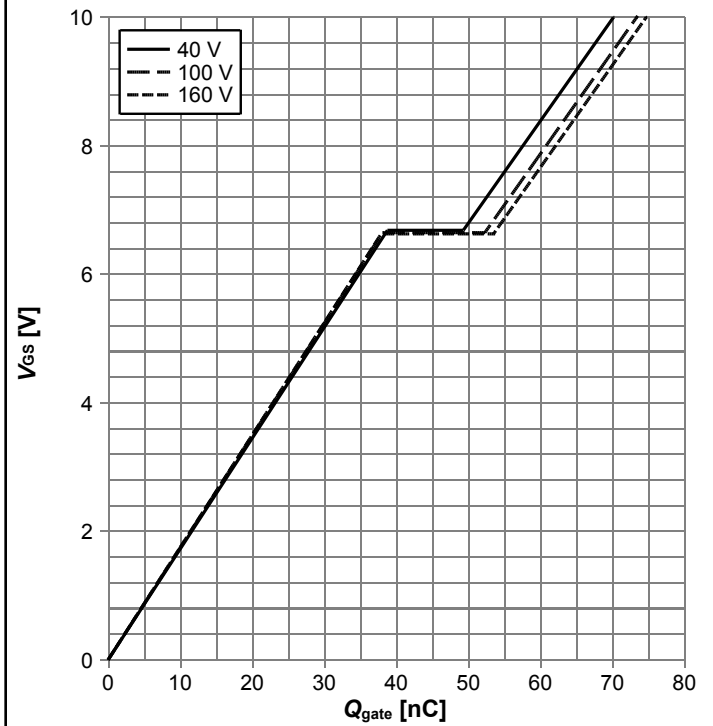


**Diagram 13: Avalanche characteristics**



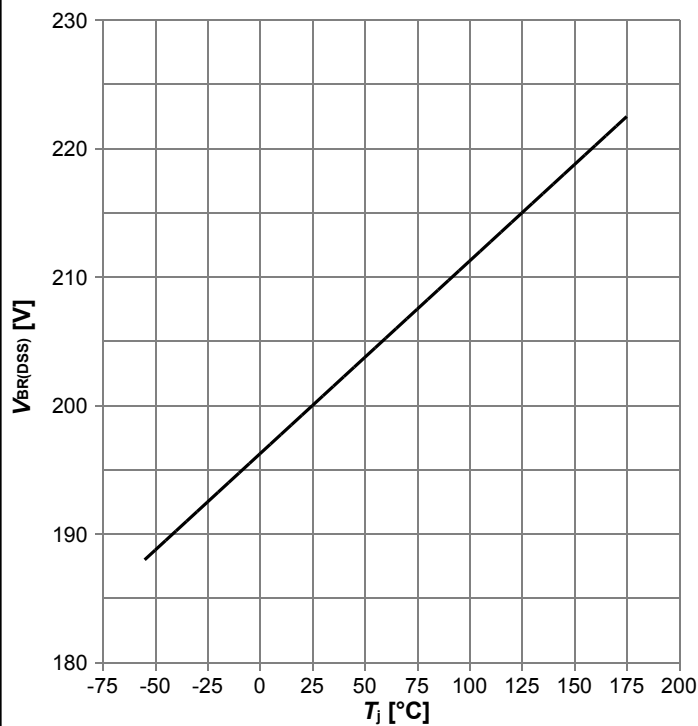
$I_{AS}=f(t_{AV}); R_{GS}=25 \Omega$ ; parameter:  $T_{j,start}$

**Diagram 14: Typ. gate charge**



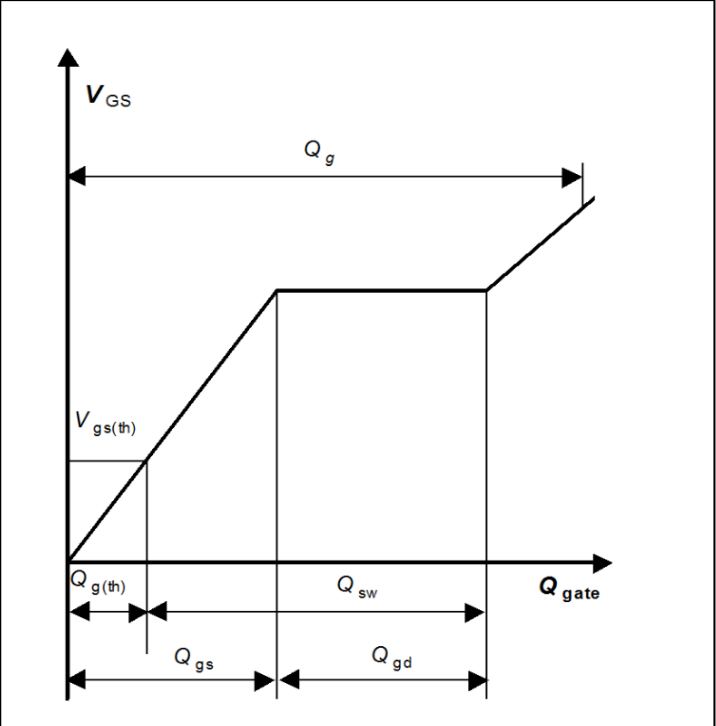
$V_{GS}=f(Q_{gate}), I_D=50 \text{ A pulsed}, T_j=25 \text{ °C}$ ; parameter:  $V_{DD}$

**Diagram 15: Drain-source breakdown voltage**

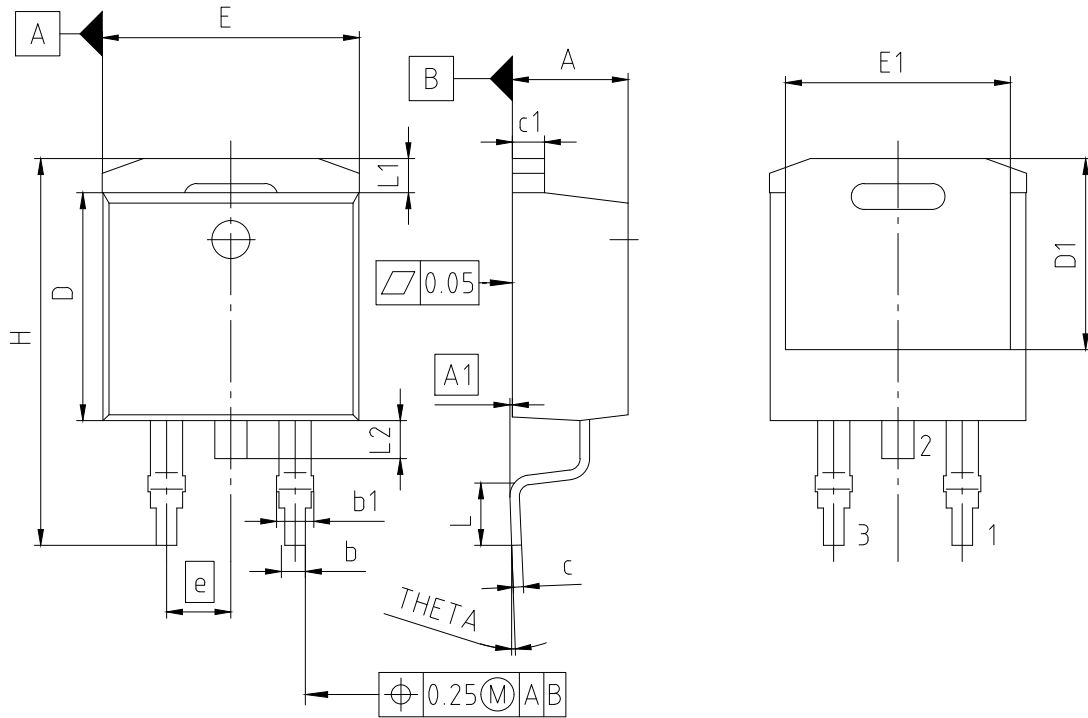


$V_{BR(DSS)}=f(T_j); I_D=1 \text{ mA}$

**Diagram Gate charge waveforms**



## 5 Package Outlines



| PACKAGE - GROUP NUMBER: <b>PG-T0263-3-U02</b> |             |       |
|---|-------------|-------|
| DIMENSIONS                                    | MILLIMETERS |       |
|   | MIN.        | MAX.  |
| A   | 4.06        | 4.83  |
| A1  | 0.00        | 0.25  |
| b   | 0.51        | 1.00  |
| b1  | 1.07        | 1.78  |
| c   | 0.30        | 0.73  |
| c1  | 1.14        | 1.65  |
| D   | 8.38        | 9.65  |
| D1  | 6.60        | 7.50  |
| E   | 9.65        | 10.67 |
| E1  | 6.22        | 8.70  |
| e   | 2.54        |       |
| N   | 3           |       |
| H   | 14.60       | 15.88 |
| L   | 1.52        | 2.60  |
| L1  | 1.05        | 1.68  |
| L2  | 1.35        | 1.78  |
| THETA   | -9.00°      | 8.00° |

PG-T0263-3-10: OPTIONAL  
5:1

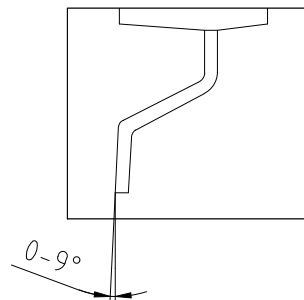


Figure 1 Outline PG-T0263-3, dimensions in mm

## Revision History

IPB068N20NM6

**Revision: 2023-10-09, Rev. 2.0**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0      | 2023-10-09 | Release of final version                     |

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[1EDC20H12AH](#) [1EDC20H12AHXUMA1](#)